GR 97 P 2215

Abstract

Method for producing electrically conductive cross connections between two wiring layers on a substrate

In the case of a three-dimensional, injection molded substrate (S), teeth (Z) are concomitantly formed during the injection-molding process in the outer edge region and/or in the region of a cutout. After the application of a metalization layer (M) to the substrate (S), extremely finely structured electrically conductive cross connections are produced by the removal of the metalization layer (M) in the region of the teeth, in particular after the teeth (Z) have been ground down or cut off.